64-Channel Serial to Parallel Converter With High Voltage Push-Pull Outputs

Features

- Processed with HVCMOS® technology
- Output voltages to 180V
- ▶ Low power level shifting
- Shift register speed:

6.0MHz @
$$V_{DD} = 5.0V$$

12MHz @ $V_{DD} = 12V$

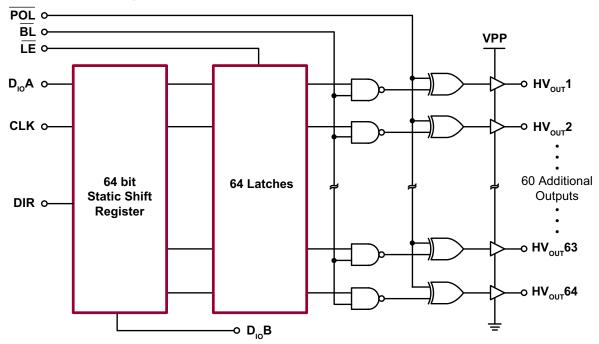
- ► Latched data outputs
- Output polarity and blanking
- ► CMOS compatible inputs
- Forward and reverse shifting options

General Description

The HV3418 is a low voltage serial to high voltage parallel converter with push-pull outputs. This device has been designed for use as a printer driver for inkjet applications. It can also be used in any application requiring multiple output, high voltage, low current sourcing and sinking capabilities.

The device consists of a 64-bit shift register, 64 latches, and control logic to perform the polarity select and blanking of the outputs. A DIR pin controls the direction of data shift through the device. With DIR grounded, $D_{IO}A$ is Data-In and $D_{IO}B$ is Data-Out; data is shifted from HV $_{OUT}64$ to HV $_{OUT}1$. When DIR is at logic high, $D_{IO}B$ is Data-In and $D_{IO}A$ is Data-Out: data is then shifted from HV $_{OUT}1$ to HV $_{OUT}64$. Data is shifted through the shift register on the low to high transition of the clock. Data output buffers are provided for cascading–devices. Operation of the shift register is not affected by the LE (latch enable), BL (blanking), or the POL(polarity) inputs. Transfer of data from the shift register to the latch occurs when the LE–(latch enable) is high. The data in the latch is stored during LE transition from high to low.

Functional Block Diagram



Ordering Information

Part Number	Package Option	Packing
HV3418PG-G	80-Lead PQFP	66/Tray

⁻G denotes a lead (Pb)-free / RoHS compliant package

Absolute Maximum Ratings

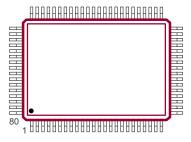
Parameter	Value
Supply voltage, V _{DD}	-0.5V to +15V
Output voltage, V _{PP}	V _{DD} to +200V
Logic input levels	-0.5V to V _{DD} +0.5V
Ground current ¹	1.5A
High voltage supply current ¹	1.3A
Continuous total power dissipation ²	1200mW
Operating temperature range	-40°C to +85°C
Storage temperature range	-65°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to GND.

Notes:

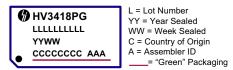
- Connection to all power and ground pads is required. Duty cycle is limited by the total power dissipated in the package.
- For operation above 25°C ambiant derate linearly to maximum operating temperature at 20mW/°C.

Pin Configuration



80-Lead PQFP (top view)

Product Marking



80-Lead PQFP

Package may or may not include the following marks: Si or 4

Typical Thermal Resistance

Package	$oldsymbol{ heta}_{ja}$
80-Lead PQFP	37°C/W

Recommended Operating Conditions

Sym	Parameter		Min	Тур	Max	Units
W	Logio gupply voltago	V _{DD} = 5.0V	4.5	5.0	5.5	V
V _{DD}	Logic supply voltage	V _{DD} = 12V	10.8	12.0	13.2	V
V _{PP}	High voltage supply		60	-	180	V
V _{IH}	High-level input voltage		V _{DD} - 0.9	-	V _{DD}	V
V _{IL}	Low-level input voltage		0	-	0.9	V
T _A	Operating free-air temperature)	-40	-	+85	°C

Power-up sequence should be the following:

- Connect ground
- Apply V_{DD}
- Set all inputs (Data, CLK, Enable, etc.) to a known state
- Apply V_{PP}

The V_{PP} should not drop below V_{DD} or float during operation.

Power-down sequence should be the reverse of the above.

DC Electrical Characteristics (Over recommended operating conditions unless otherwise noted)

Sym	Parameter		Min	Max	Units	Conditions			
I _{DD}	V _{DD} supply current		-	25	mA	$f_{CLK} = 12MHz, f_{DATA} = 12MHz, \overline{LE} = low$			
I _{DDQ}	Quiescent V _{DD} supply	current	-	200	μΑ	All V _{IN} = 0 or V _{DD}			
	High voltage cupply o	urront	-	0.50	mA	V _{PP} = 180V. All outputs high.			
l _{PP}	High voltage supply o	unent	-	0.50	IIIA	V _{PP} = 180V. All outputs low.			
I _{IH}	High-level logic input	-	10	μΑ	$V_{IH} = V_{DD}$				
I	Low-level logic input	-	-10	μΑ	V _{IL} = 0V				
V	High level output	HV _{OUT}	155	-	V	V _{PP} = 180V, IHV _{OUT} = -5.0mA,			
V _{OH}	High level output	D _{OUT}	V _{DD} - 1.0V	-	V	$ID_{OUT} = -100\mu A$			
V	Low level output	HV _{OUT}	-	25	V	$V_{pp} = 180V, IHV_{OUT} = +5.0mA,$			
V _{OL}	Low level output	D _{OUT}	-	1.0	V	ID _{OUT} = +100μA			
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \			-	V _{DD} + 1.5	V	I _{OL} = +5.0mA			
V _{oc}	HV _{OUT} clamp voltage		-	-1.5	V	I _{oL} = -5.0mA			

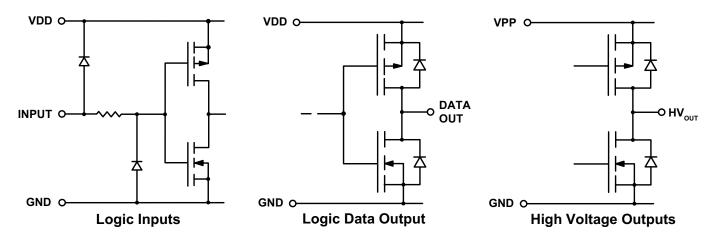
AC Electrical Characteristics (For V_{DD} = 12V. Values in parentheses are for V_{DD} = 5.0V, V_{PP} = 180V, T_A = 25°C)

Sym	Parameter	Min	Max	Units	Conditions
f _{CLK}	Clock frequency	-	12 (6.0)	MHz	
t _w	Clock width high or low	40 (83)	-	ns	
t _{su}	Data set-up time before clock rises	25 (35)	-	ns	
t _H	Data hold time after clock rises	10 (30)	-	ns	
t _{WLE}	TE pulse width	62 (80)	-	ns	
t _{DLE}	Delay time clock to LE high to low	25 (35)	-	ns	
t _{SLE}	E set-up time before clock rises	30 (40)	-	ns	
t _{ON} , t _{OFF}	Time from LE to HV _{OUT}	-	1.0 (1.5)	μs	C _L = 20pF
t _{DHL}	Delay time clock to data high to low	-	50 (110)	ns	C _L = 20pF
t _{DLH}	Delay time clock to data low to high	-	75 (160)	ns	C _L = 20pF
t _R , t _F	All logic inputs	-	5.0	ns	

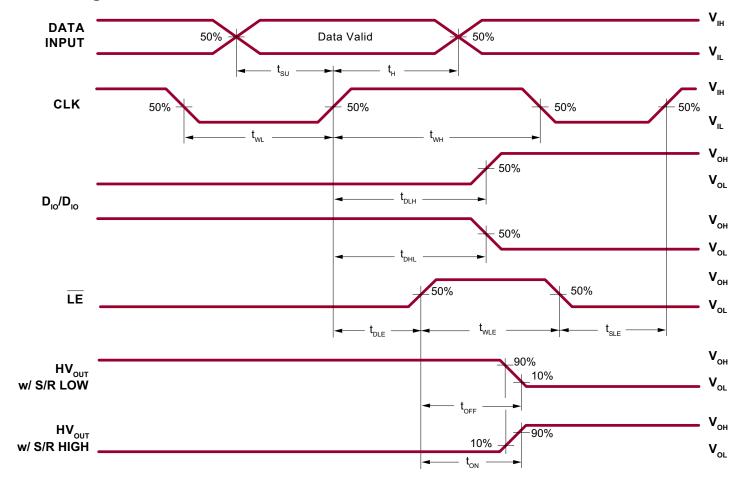
Notes:

- Shift register speed can be as low as DC as long as data set-up and hold time meet the spec.
 AC characteristics are guaranteed only under V_{DD} = 12V and V_{DD} = 5.0V.

Input and Output Equivalent Circuits



Switching Waveforms



Function Table

		I	nputs				Outputs						
Function	Data	CLK	LE	BL	POL	DIR	Shift	Reg	HV C	utputs	Data Out		
	Data	OLIK			I OL	DIIX	1	264	1	264	*		
All on	Х	Х	Х	L	L	Х	*	**	Н	НН	*		
All off	Х	Х	Х	L	Н	Х	*	**	L	LL	*		
Invert mode	Х	Х	L	Н	L	Х	*	**	*	**	*		
Load S/R	H or L	1	L	Н	Н	Х	H or L	**	*	**	*		
Load/store	Х	Х	↓	Н	Н	Х	*	**	*	**	*		
data in latches	Х	Х	↓	Н	L	Х	*	**	*	**	*		
Transparent	L	1	Н	Н	Н	Х	L	**	L	**	*		
latch mode	Н	1	Н	Н	Н	Х	Н	**	Н	**	*		
I/O relation	D _{IO} A	1	Х	Х	Х	L	$Q_N \rightarrow$	Q_{N+1}		-	D _{IO} B		
I/O relation	D _{IO} B	1	Х	Х	Х	Н	$Q_N \rightarrow$	Q_{N+1}		-	D _{IO} A		

Notes:

H = high level, L = low level = 0V, X = irrelevant, ↑ = low-to-high transition, ↓ = high-to-low transition.

* = dependent on previous stage's state before the last CLK or last LE high.

Pin Description

I III Descii	Ption
Pin #	Function
1	HV _{OUT} 41/24
2	HV _{out} 42/23
3	HV _{out} 43/22
4	HV _{OUT} 44/21
5	HV _{OUT} 45/20
6	HV _{out} 46/19
7	HV _{OUT} 47/18
8	HV _{OUT} 48/17
9	HV _{out} 49/16
10	HV _{out} 50/15
11	HV _{OUT} 51/14
12	HV _{оυт} 52/13
13	HV _{оυт} 53/12
14	HV _{OUT} 54/11
15	HV _{оυт} 55/10
16	HV _{ουτ} 56/9
17	HV _{ουτ} 57/8
18	HV _{ουτ} 58/7
19	HV _{ουτ} 59/6
20	HV _{оυт} 60/5
21	HV _{оυт} 61/4
22	HV _{ουτ} 62/3
23	HV _{ουτ} 63/2
24	HV _{оυт} 64/1
25	VPP
26	D _{IO} A
27	N/C

Pin #	Function
28	N/C
29	BL
30	POL
31	VDD
32	DIR
33	LGND
34	OGND
35	N/C
36	N/C
37	CLK
38	LE
39	D _{IO} B
40	VPP
41	HV _{оυт} 1/64
42	HV _{оит} 2/63
43	HV _{оит} 3/62
44	HV _{оυт} 4/61
45	HV _{оит} 5/60
46	HV _{оит} 6/59
47	HV _{оυт} 7/58
48	HV _{оит} 8/57
49	HV _{оит} 9/56
50	HV _{OUT} 10/55
51	HV _{OUT} 11/54
52	HV _{OUT} 12/53
53	HV _{OUT} 13/52
54	HV _{OUT} 14/51

Pin #	Function
55	HV _{out} 15/50
56	HV _{out} 16/49
57	HV _{OUT} 17/48
58	HV _{OUT} 18/47
59	HV _{out} 19/46
60	HV _{OUT} 20/45
61	HV _{OUT} 21/44
62	HV _{OUT} 22/43
63	HV _{оит} 23/42
64	HV _{OUT} 24/41
65	HV _{OUT} 25/40
66	HV _{оит} 26/39
67	HV _{OUT} 27/38
68	HV _{OUT} 28/37
69	HV _{оит} 29/36
70	HV _{оит} 30/35
71	HV _{оит} 31/34
72	HV _{OUT} 32/33
73	HV _{OUT} 33/32
74	HV _{оит} 34/31
75	HV _{OUT} 35/30
76	HV _{OUT} 36/29
77	HV _{OUT} 37/28
78	HV _{оит} 38/27
79	HV _{оит} 39/26
80	HV _{OUT} 40/25

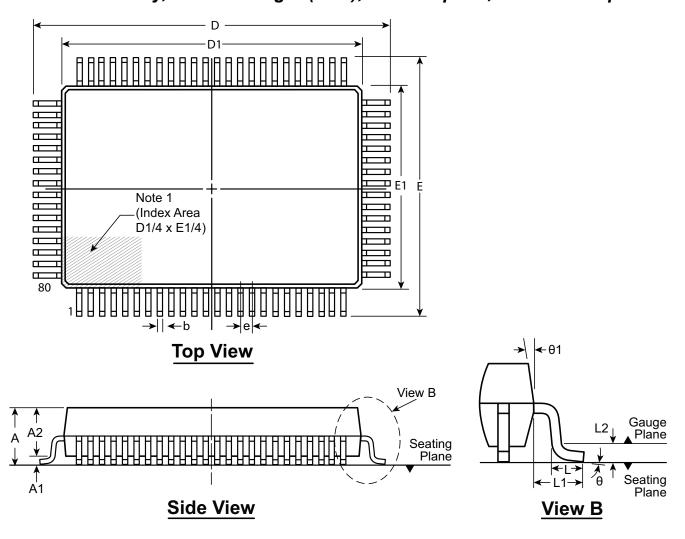
Notes:

Pin designation for DIR = H/L Example:

for DIR = H, Pin 1 is $HV_{OUT}41$ for DIR = L, Pin 1 is $HV_{OUT}24$

80-Lead PQFP Package Outline (PG)

20.00x14.00mm body, 3.40mm height (max), 0.80mm pitch, 3.90mm footprint



Note:

 A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbo	ol	Α	A1	A2	b	D	D1	E	E1	е	L	L1	L2	θ	θ1
Dimen-	MIN	2.80*	0.25	2.55	0.30	23.65*	19.80*	17.65*	13.80*		0.73			0 °	5°
sion	NOM	-	-	2.80	-	23.90	20.00	17.90	14.00	0.80 BSC	0.88	1.95 REF	0.25 BSC	3.5°	-
(mm)	MAX	3.40	0.50*	3.05	0.45	24.15*	20.20*	18.15*	14.20*	Воо	1.03	1 (_ 1	200	7 °	16°

JEDEC Registration MO-112, Variation CB-1, Issue B, Sept.1995.

Drawings not to scale.

Supertex Doc. #: DSPD-80PQFPPG, Version C041309.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

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^{*} This dimension is not specified in the JEDEC drawing.